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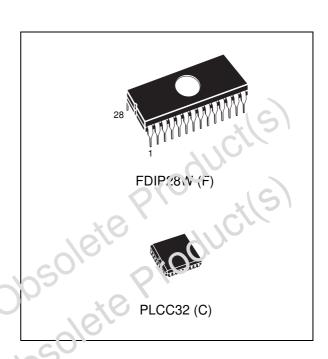
# M87C257

# Address Latched 256 Kbit (32Kb x8) UV EPROM and OTP EPROM

### Feature summary

- 5V ± 10% supply voltage in Read operation
- Integrated address latch
- Access time: 45ns
- Low power consumption:
  - Active Current 30mA
  - Standby Current 100μA
- Programming voltage: 12.75V ± 0.25V
- Programming times of around 3s
- Electronic signature
  - Manufacturer Code: 20h
  - Device Code: 80h
- ECOPACK® packages available

  Obsolete Product(s)



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M87C257 Description

# 1 Description

The M87C257 is a 256 Kbit EPROM offered in the two ranges UV (ultra violet erase) and OTP (one time programmable). It incorporates latches for all address inputs to minimize chip count, reduce cost, and simplify the design of multiplexed bus systems and is organized as 32,768 by 8 bits.

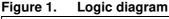
The FDIP28W (window ceramic frit-seal package) has a transparent lid which allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written to the device by following the programming procedure.

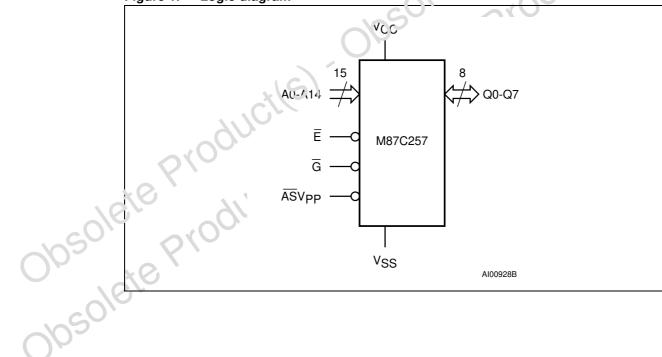
For applications where the content is programmed only one time and erasure is not required, the M87C257 is offered in PLCC32 package.

In order to meet environmental requirements, ST offers the M87C257 in ECOPACKOP packages.

ECOPACK packages are Lead-free. The category of second Level Intercopriect is marked on the package and on the inner box label, in compliance with JED'EC Clandard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.





**Description** M87C257

Table 1. Signal names

A0-A14	Address Inputs
Q0-Q7	Data Outputs
Ē	Chip Enable
G	Output Enable
<del>AS</del> V <sub>PP</sub>	Address Strobe / Program Supply
V <sub>CC</sub>	Supply Voltage
V <sub>SS</sub>	Ground
NC	Not Connected Internally
DU	Don't Use

Figure 2. **DIP** connections

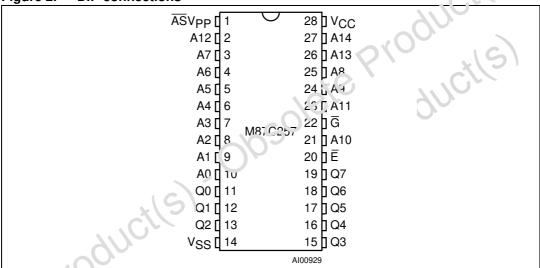
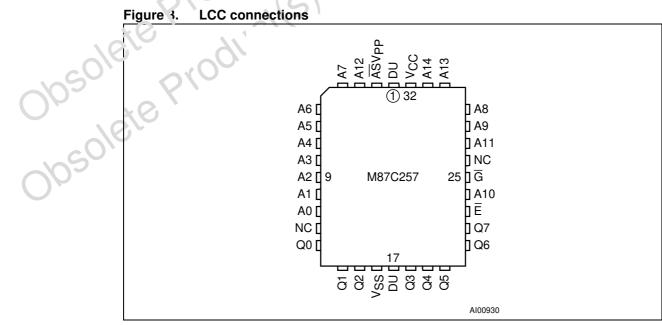


Figure ₹. LCC connections



M87C257 Device operation

# 2 Device operation

The modes of operation of the M87C257 are listed in the Operating Modes. A single power supply is required in the read mode. All inputs are TTL levels except for  $V_{PP}$  and 12V on A9 for Electronic Signature.

#### 2.1 Read mode

The M87C257 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable  $(\overline{E})$  is the power control and should be used for device selection. Output Enable  $(\overline{G})$  is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that the addresses are stable  $(\overline{AS} = V_{IH})$  or latched  $(\overline{AS} = V_{IL})$ , the address access time  $(t_{AVQV})$  is equal to the delay from  $\overline{E}$  to output  $(t_{ELQV})$ . Data is available at the output after delay of  $t_{GLQV}$  from the failing edge of  $\overline{G}$ , assuming that  $\overline{E}$  has been low and the addresses have been stable for at least  $t_{AVQV}$   $t_{GLQV}$ . The M87C257 reduces the hardware interface in multiplexed address-data bus systems. The processor multiplexed bus (AD0-AD7) may be for the M87C257's address and data pins. No separate address latch is needed because the M87C257 latches all address inputs when  $\overline{AS}$  is low.

## 2.2 Standby mode

The M87C257 has a standby mode which reduces the active current from 30mA to 100 $\mu$ A (Address Stable). The M87C257 is placed in the standby mode by applying a CMOS high signal to the  $\overline{E}$  input. When in the standby mode, the outputs are in a high impedance state, independent of the  $\overline{G}$  input.

# 2.3 Two Line Output Control

Because EPROMs are usually used in larger memory arrays, this product features a 2 line control function which accommodates the use of multiple memory connection. The two line control function allows:

- the lowest possible memory power dissipation,
- complete assurance that output bus contention will not occur.

For the most efficient use of these two control lines,  $\overline{E}$  should be decoded and used as the primary device selecting function, while  $\overline{G}$  should be made a common connection to all devices in the array and connected to the  $\overline{READ}$  line from the system control bus. This ensures that all deselected memory devices are in their low power standby mode and that the output pins are only active when data is desired from a particular memory device.

Device operation M87C257

### 2.4 System considerations

The power switching characteristics of Advance CMOS EPROMs require careful decoupling of the devices. The supply current,  $I_{CC}$ , has three segments that are of interest to the system designer: the standby current level, the active current level, and transient current peaks that are produced by the falling and rising edges of  $\overline{E}$ . The magnitude of this transient current peaks is dependent on the capacitive and inductive loading of the device at the output. The associated transient voltage peaks can be suppressed by complying with the two line output control and by properly selected decoupling capacitors. It is recommended that a  $0.1\mu F$  ceramic capacitor be used on every device between  $V_{CC}$  and  $V_{SS}$ . This should be a high frequency capacitor of low inherent inductance and should be placed as close to the device as possible. In addition, a  $4.7\mu F$  bulk electrolytic capacitor should be used between  $V_{CC}$  and  $V_{SS}$  for every eight devices. The bulk capacitor should be located near the power supply connection point. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of PCB traces.

### 2.5 Programming

When delivered (and after each erasure for UV EPROM), all Lis or the M87C257 are in the '1' state. Data is introduced by selectively programming 'C's into the desired bit locations. Although only '0's will be programmed, both '1's and '0's can be present in the data word. The only way to change a '0' to a '1' is by die expection to ultraviolet light (UV EPROM). The M87C257 is in the programming mode when  $\dot{v}_{\rm PF}$  input is at 12.75V,  $\dot{\rm G}$  is at  $V_{\rm IL}$  and  $\dot{\rm E}$  is pulsed to  $V_{\rm IL}$ . The data to be programmed is applied to 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.  $V_{\rm CC}$  is specified to be 6.25 V  $\pm$  0.25 V.

## 2.6 PRESTO II programming algorithm

PRESTO II Programming Algorithm allows to program the whole array with a guaranteed margin, in a prical time of 3.5 seconds. Programming with PRESTO II involves the application of a sequence of 100µs program pulses to each byte until a correct verify occurs (see Figure 4). During programming and verify operation, a MARGIN MODE circuit is a necnatically activated in order to guarantee that each cell is programmed with enough anargin. No overprogram pulse is applied since the verify in MARGIN MODE provides necessary margin to each programmed cell.

M87C257 **Device operation** 

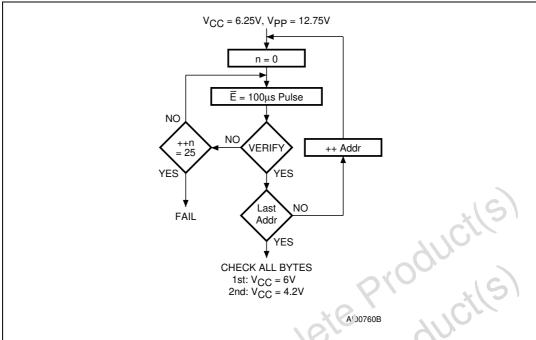


Figure 4. **Programming flowchart** 

#### 2.7 **Program Inhibit**

Programming of multiple M87C257s in parallel with different data is also easily accomplished. Except for  $\overline{E}$  all like inputs including  $\overline{G}$  of the parallel M87C257 may be common. A TTL low level pulse applied to a M87C257's  $\overline{E}$  input, with  $V_{PP}$  at 12.75V, will program that M87C257. A high level  $\overline{E}$  input inhibits the other M87C257s from being programmed.

#### Program Verify 2.8

A verify (read) correctly progra V<sub>CC</sub> at 6.25V. A verify (read) should be performed on the programmed bits to determine that they were correctly programmed. The verify is accomplished with  $\overline{G}$  at  $V_{IL}$ ,  $\overline{E}$  at  $V_{IH}$ ,  $V_{PP}$  at 12.75V and

Device operation M87C257

### 2.9 Electronic signature

The Electronic Signature (ES) mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. The ES mode is functional in the 25°C  $\pm$  5°C ambient temperature range that is required when programming the M87C257.

To activate the ES mode, the programming equipment must force 11.5V to 12.5V on address line A9 of the M87C257, with  $V_{CC} = V_{PP} = 5V$ . Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from  $V_{IL}$  to  $V_{IH}$ . All other address lines must be held at  $V_{IL}$  during Electronic Signature mode. Byte 0 (A0 =  $V_{IL}$ ) represents the manufacturer code and byte 1 (A0 =  $V_{IH}$ ) the device identifier code. When A9 =  $V_{ID}$ ,  $\overline{AS}$  need not be toggled to latch each identifier address. For the STMicroelectronics M87C257, these two identifier bytes are given in *Table 4* and can be read-out on outputs Q7 to Q0.

## 2.10 Erasure operation (applies for UV EPROM)

The erasure characteristics of the M87C257 is such that erasure begins when the cells are exposed to light with wavelengths shorter than approxil to (e) 4000 Å. It should be noted that sunlight and some type of fluorescent lamps have vavelengths in the 3000-4000 Å range. Research shows that constant exposure of com level fluorescent lighting could erase a typical M87C257 in about 3 years. While it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the M87C257 is to be exposed to these types of lighting conditions for extended periods of time, it is suggested that opaque labels be put over the M87C257 window to prevent unintentional erasure. The recommended erasure procedure for the M87C257 is exposure to short wave ultraviolet light which has wavelength 2537Å. The magnated dose (i.e. UV intensity x exposure time) for erasure should be a minimum of 15 W-sec/cm². The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with 12000 µW/cm² power rating. The M87C257 should be placed within 2.5 cm (1 inch) of the lamp tubes during the erasure. Some lamps have a filler on their tubes which should be removed before erasure.

M87C257 Maximum rating

#### **Maximum rating** 3

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 2. **Absolute maximum ratings** 

Symbol	Parameter	Value	Unit
T <sub>A</sub>	Ambient Operating Temperature <sup>(1)</sup>	-40 to 125	C)°
T <sub>BIAS</sub>	Temperature Under Bias	-50 to 125	°C
T <sub>STG</sub>	Storage Temperature	−60 to 150	°C
V <sub>IO</sub> <sup>(2)</sup>	Input or Output Voltage (except A9)	-2 to 7	V
V <sub>CC</sub>	Supply Voltage	–2 to 7	<b>V</b>
V <sub>A9</sub> <sup>(2)</sup>	A9 Voltage	−2 to 13.5	V
V <sub>PP</sub>	Program Supply Voltage	-2 to 14	V

<sup>1.</sup> Depends on range.

Table 3. Operating modes

Mode	E	G	A9	ASV <sub>PP</sub>	Q7-Q0
Read (Latched Factress)	V <sub>IL</sub>	$V_{IL}$	Х	V <sub>IL</sub>	Data Out
Read (^.pc'ed Address)	V <sub>IL</sub>	V <sub>IL</sub>	Х	V <sub>IH</sub>	Data Out
Output Disable	V <sub>IL</sub>	V <sub>IH</sub>	Х	Х	Hi-Z
Program	V <sub>IL</sub> Pulse	V <sub>IH</sub>	Х	V <sub>PP</sub>	Data In
Verify	V <sub>IH</sub>	V <sub>IL</sub>	Х	V <sub>PP</sub>	Data Out
Program Inhibit	V <sub>IH</sub>	V <sub>IH</sub>	Х	V <sub>PP</sub>	Hi-Z
Standby	V <sub>IH</sub>	Х	Х	Х	Hi-Z
Electronic Signature	V <sub>IL</sub>	V <sub>IL</sub>	V <sub>ID</sub>	V <sub>IL</sub>	Codes
1. $X = V_{IH} \text{ or } V_{IL}, V_{ID} = 12V \pm 0$	0.5V.				
Table 4. Electronic s	signature				

<sup>1.</sup>  $X = V_{IH} \text{ or } V_{IL}, V_{ID} = 12V \pm 0.5V.$ 

Electronic signature

Identifier	A0	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0	Hex Data
Manufacturer's Code	$V_{IL}$	0	0	1	0	0	0	0	0	20h
Device Code	V <sub>IH</sub>	1	0	0	0	0	0	0	0	80h

<sup>2.</sup> Minimum DC voltage on Input or Output is −0.5 / ::\(\text{\text{in}}\) possible undershoot to −2.0V for a period less than 20ns. Maximum DC voltage on Output is \(\text{\text{V}}\).5V with possible overshoot to \(\text{V}\)\_C +2V for a period less than 20ns.

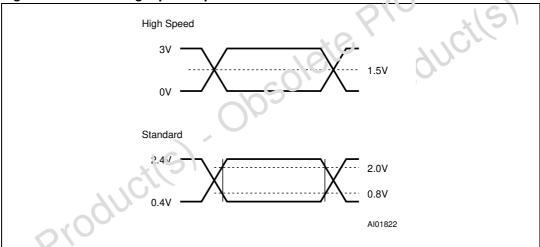
#### 4 DC and AC parameters

This section summarizes the operating and measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC Characteristic tables that follow are derived from tests performed under the Measurement Conditions summarized in the relevant tables. Designers should check that the operating conditions in their circuit match the measurement conditions when relying on the quoted parameters.

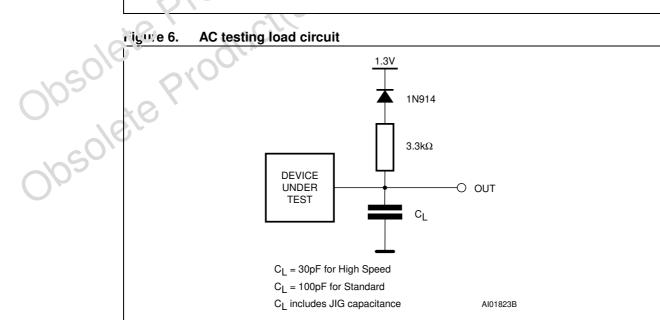
Table 5. **AC** measurement conditions

	High Speed	Standard
Input Rise and Fall Times	≤10ns	<b>⊴</b> 20ns
Input Pulse Voltages	0 to 3V	0.4V to 2.4v
Input and Output Timing Ref. Voltages	1.5V	0.9\' a 10 2V

Figure 5. AC testing input output waveform



AC testing load circuit



Capacitance<sup>(1) (2)</sup> Table 6.

Symbol	Parameter	Test Condition	Min	Max	Unit
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$		6	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V		12	pF

<sup>1.</sup>  $T_A = 25$  °C, f = 1 MHz

Read mode DC characteristics<sup>(1)</sup> (2) Table 7.

Symbol	Parameter	Test Condition	Min	Max	Unit
I <sub>LI</sub>	Input Leakage Current	0V ≤V <sub>IN</sub> ≤V <sub>CC</sub>		±10	μΑ
I <sub>LO</sub>	Output Leakage Current	0V ≤V <sub>OUT</sub> ≤V <sub>CC</sub>		±10	uA
I <sub>CC</sub>	Supply Current	$\overline{E} = V_{IL}, \overline{G} = V_{IL},$ $I_{OUT} = 0mA, f = 5MHz$	1,1	30	mA
laa.	$\overline{E} = V_{IH}, \overline{AS}V_{PP} = V_{IH}, Address$ Supply Current Switching		100/	10	mA
I <sub>CC1</sub>	(Standby) TTL	$\overline{E} = V_{IH,} \overline{AS} V_{PP} = V_{IL}, Address$ Stable		Cit	mA
	Supply Current	$\overline{E} > V_{CC} - 0.2V$ , $\overline{A3V_{PP}} \ge V_{CC} - 0.2V$ , Address Syntching	"OQ/	6	mA
I <sub>CC2</sub>	(Standby) CMOS	$\overline{E} > V_{CC} - 7.2 \text{V}, \overline{ASV}_{PP} = V_{SS},$ Address Stable		100	μΑ
I <sub>PP</sub>	Program Current	$V_{PP} = V_{CC}$		100	μΑ
V <sub>IL</sub>	Input Low Voltage	60/	-0.3	8.0	V
V <sub>IH</sub> <sup>(3)</sup>	Input High Voitage	0/02	2	V <sub>CC</sub> + 1	٧
V <sub>OL</sub>	Output \ cw \ voltage	I <sub>OL</sub> = 2.1mA		0.4	V
V <sub>OH</sub>	Output High Voltage	$I_{OH} = -1 \text{mA}$	V <sub>CC</sub> - 0.8V		V

<sup>1.</sup>  $T_A = 7$  to 70 °C, -40 to 85 °C; -40 to 105 °C or -40 to 125 °C;  $V_{CC} = 5V \pm 5\%$  or  $5V \pm 10\%$ ;  $V_{PP} = V_{CC}$ 

	V <sub>OL</sub>	Output. Cw Voltage	$I_{OL} = 2.1 \text{mA}$		0.4	V				
	V <sub>OH</sub>	Output High Voltage	$I_{OH} = -1 \text{mA}$	V <sub>CC</sub> -	V8.0	V				
		$T_A = \%$ to 70 °C, -40 to 85 °C; -40 to 105 °C or -40 to 125 °C; $V_{CC} = 5V \pm 5\%$ or $5V \pm 10\%$ ; $V_{PP} = V_{CC}$								
			vith or before V <sub>PP</sub> and removed	d simultaneousl	y or after $V_{PP}$ .					
7/6	3. Maximum DC voltage on Output is V <sub>CC</sub> +0.5V.									
100.	Table 8.	Programming mode	e DC characteristics <sup>(1)</sup> (	2)						
002	Symbol	Parameter	Test Condition	Min	Max	Unit				
\( \)	YLI	Input Leakage Current	$V_{IL} \leq V_{IN} \leq V_{IH}$		±10	μΑ				
0/6	I <sub>CC</sub>	Supply Current			50	mA				
2009	I <sub>PP</sub>	Program Current	$\overline{E} = V_{IL}$		50	mA				
$\bigcirc$	$V_{IL}$	Input Low Voltage		-0.3	0.8	V				
	V <sub>IH</sub>	Input High Voltage		2	V <sub>CC</sub> + 0.5	V				
	$V_{OL}$	Output Low Voltage	I <sub>OL</sub> = 2.1mA		0.4	V				
	V <sub>OH</sub>	Output High Voltage TT	$I_{OH} = -1 \text{mA}$	$V_{CC} - 0.8$		V				
	$V_{ID}$	A9 Voltage		11.5	12.5	V				

<sup>1.</sup>  $T_A = 25$  °C;  $V_{CC} = 6.25V \pm 0.25V$ ;  $V_{PP} = 12.75V \pm 0.25V$ 

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<sup>2.</sup> Sampled only, not 100% tested.

<sup>?.</sup>  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ .

<sup>2.</sup>  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ .

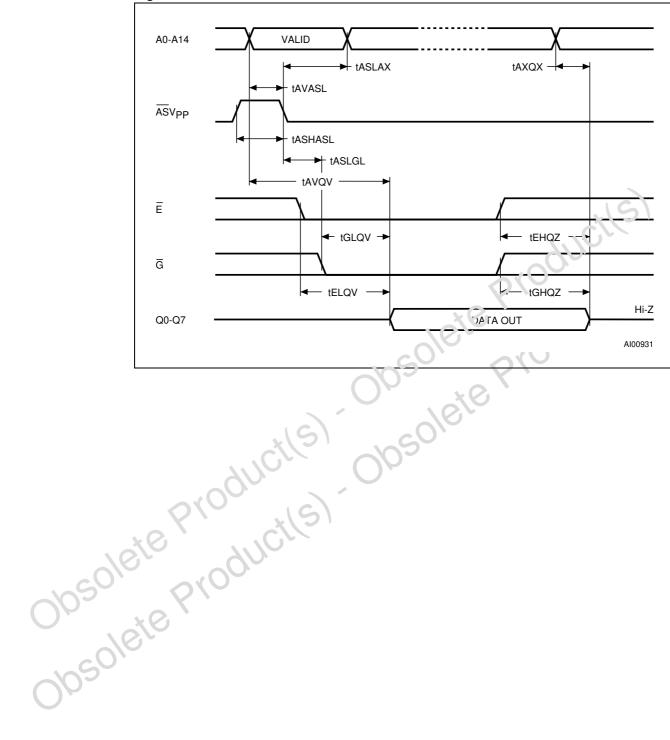


Figure 7. Read mode AC waveforms

Read mode AC characteristics 1<sup>(1)</sup> (2) Table 9.

				M87C257								
Symbol	Alt	Parameter	Test Condition	-4:	-45 <sup>(3)</sup>		60	-70		-80		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>AVQV</sub>	t <sub>ACC</sub>	Address Valid to Output Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$		45		60		70		80	ns
t <sub>AVASL</sub>	t <sub>AL</sub>	Address Valid to Address Strobe Low		7		7		7		7		ns
t <sub>ASHASL</sub>	t <sub>LL</sub>	Address Strobe High to Address Strobe Low			35		35	35		35		ns
t <sub>ASLAX</sub>	$t_{LA}$	Address Strobe Low to Address Transition			20		20	20		23	5	ns
t <sub>ASLGL</sub>	t <sub>LOE</sub>	Address Strobe Low to Output Enable Low			20		20	20	910	20		ns
t <sub>ELQV</sub>	t <sub>CE</sub>	Chip Enable Low to Output Valid	$\overline{G} = V_{IL}$		45	C	٥0		70	Č	80	ns
t <sub>GLQV</sub>	t <sub>OE</sub>	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$		25		30		35		40	ns
t <sub>EHQZ</sub> <sup>(4)</sup>	t <sub>DF</sub>	Chip Enable High to Output Hi-Z	Ḡ = V′ <sub>IL</sub>	0	25	0	30	0	30	0	40	ns
t <sub>GHQZ</sub> <sup>(4)</sup>	t <sub>DF</sub>	Output Enable High to Output Hi-Z	E = V <sub>IL</sub>	0	25	0	30	0	30	0	40	ns
t <sub>AXQX</sub>	t <sub>OH</sub>	Address Transition to Output Transition	$\overline{\overline{E}} = V_{IL},$ $\overline{G} = V_{IL}$	0		0		0		0		ns

<sup>1.</sup>  $T_A = 0$  to 70 °C. – 4\cdot to 85 °C; –40 to 105 °C or –40 to 125 °C;  $V_{CC} = 5V \pm 5\%$  or  $5V \pm 10\%$ ;  $V_{PP} = V_{CC}$ 

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4. Samp. ad only, not 100% 2.  $V_{CC}$  must because y in y and y are y and y and y are y a

<sup>3.</sup> Speed Jovained with High Speed AC measurement conditions.

<sup>4.</sup> Sampled only, not 100% tested.

Read mode AC characteristics 2<sup>(1)</sup> (2) Table 10.

							M87	C257				
Symbol	Alt	Parameter	Test Condition	-90		-10		-12		-15/-20		Unit
				Min	Max	ax Min Max		Min Max		Min Max		
t <sub>AVQV</sub>	t <sub>ACC</sub>	Address Valid to Output Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$		90		100		120		150	ns
t <sub>AVASL</sub>	t <sub>AL</sub>	Address Valid to Address Strobe Low		7		7		7		7		ns
t <sub>ASHASL</sub>	t <sub>LL</sub>	Address Strobe High to Address Strobe Low		35		35		35		35	S	ns
t <sub>ASLAX</sub>	t <sub>LA</sub>	Address Strobe Low to Address Transition		20		20		20	97	20		ns
† <sub>ASLGL</sub>	t <sub>LOE</sub>	Address Strobe Low to Output Enable Low		20		20	6	20		20	(5)	ns
t <sub>ELQV</sub>	t <sub>CE</sub>	Chip Enable Low to Output Valid	G = V <sub>IL</sub>		9,7		100		120	)	150	ns
t <sub>GLQV</sub>	t <sub>OE</sub>	Output Enable Low to Output Valid	E-Vil	5	40	. 0	40		50		60	ns
t <sub>EHQZ</sub> (3)	t <sub>DF</sub>	Chip Enable High to Output Hi-Z	G = V <sub>IL</sub>	0	40	0	30	0	40	0	40	ns
t <sub>GHQZ</sub> (3)	t <sub>DF</sub>	Output Erable High to Output Hi Z	$\overline{E} = V_{JL}$	0	40	0	30	0	40	0	40	ns
t <sub>AXQX</sub>	tor	Andress Transition to Output Transition	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	0		0		0		0		ns
2. V <sub>CC</sub> m	to 7J °( ust be a ed only	C, -40 to 85 °C; -40 to 1 applied simultaneously want 100% tested.										

<sup>1.</sup>  $T_A = \%$  to 70 °C, -40 to 85 °C; -40 to 105 °C or -40 to 125 °C;  $V_{CC} = 5V \pm 5\%$  or  $5V \pm 10\%$ ;  $V_{PP} = V_{CC}$ 

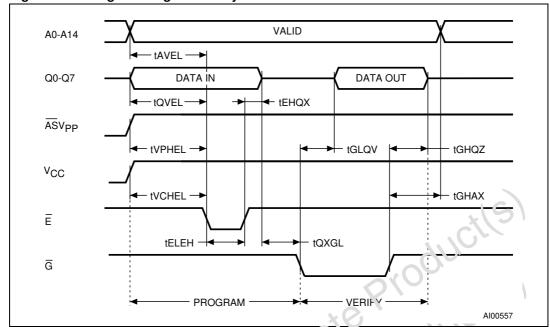


Figure 8. **Programming and Verify modes AC waveforms** 

Programming mode AC characteristics (1) (2) Table 11.

	Symbol	Alt	Parame'(e)	Test Condition	Min	Max	Unit
	t <sub>AVEL</sub>	t <sub>AS</sub>	Address Valid to Chip Enable Low		2		μs
	t <sub>QVEL</sub>	t <sub>DS</sub>	Input Valid to Chip Enable Low		2		μs
	t <sub>VPHEL</sub>	t <sub>VPS</sub>	V <sub>PP</sub> 'High to Chip Enable Low		2		μs
	t <sub>VCHEL</sub>	t <sub>VCS</sub>	√ <sub>C☉</sub> High to Chip Enable Low		2		μs
	t <sub>ELE</sub> ,	t <sub>FW</sub>	Chip Enable Program Pulse Width		95	105	μs
	t <sub>FHQX</sub>	t <sub>DH</sub>	Chip Enable High to Input Transition		2		μs
\ C	luxGL	t <sub>OES</sub>	Input Transition to Output Enable Low		2		μs
	t <sub>GLQV</sub>	t <sub>OE</sub>	Output Enable Low to Output Valid			100	ns
2050	t <sub>GHQZ</sub>	t <sub>DFP</sub>	Output Enable High to Output Hi-Z		0	130	ns
Ob	t <sub>GHAX</sub>	t <sub>AH</sub>	Output Enable High to Address Transition		0		ns
	1. T <sub>A</sub> = 25	°C; V <sub>CC</sub>	$= 6.25V \pm 0.25V; V_{PP} = 12.75V \pm 0.25V$				•
0,020	2. V <sub>CC</sub> mu	st be app	olied simultaneously with or before V <sub>PP</sub> and rem	oved simultaneous	sly or after	V <sub>PP</sub> .	

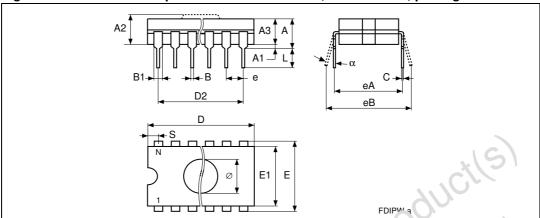
<sup>1.</sup>  $T_A = 25$  °C;  $V_{CC} = 6.25V \pm 0.25V$ ;  $V_{PP} = 12.75V \pm 0.25V$ 

<sup>2.</sup>  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ .

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# 5 Package mechanical

Figure 9. FDIP28W - 28 pin Ceramic Frit-seal DIP, with window, package outline



<sup>1.</sup> Drawing is not to scale.

Table 12. FDIP28WB - 28 pin Ceramic Frit-seal D!P, with window (round 0.280"), package mechanical data

		puokuge me	ciiailicai dat	и			
	Symbol		millimeters	c0)		inches	
	Symbol	Тур	Min	Max	Тур	Min	Max
	Α			5.72			0.225
	A1	. 1	0.51	1.40		0.020	0.055
	A2	· c\	3.91	4.57		0.154	0.180
	A3	AU	3.89	4.50		0.153	0.177
	В	00,	0.41	0.56		0.016	0.022
	В	1.45	(5)	-	0.057	-	_
	8c	1.1C	0.23	0.30		0.009	0.012
7/6	D	70,n	36.50	37.34		1.437	1.470
1250.	D2	33.02	_	_	1.300	-	_
Dh.	E	15.24	_	_	0.600	-	_
\( \( \)	E1		13.06	13.36		0.514	0.526
	е	2.54	_	_	0.100	-	_
102	eA	14.99	_	_	0.590	-	_
) •	eB		16.18	18.03		0.637	0.710
	L		3.18	4.10		0.125	0.161
	α		4°	11°		4°	11°
	S		1.52	2.49		0.060	0.098
	Ø	7.11	-	_	0.280	-	_
	N		28			28	

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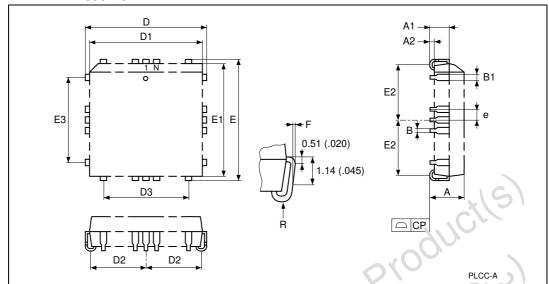


Figure 10. PLCC32 - 32 pin Rectangular Plastic Leaded Chip Carrier, package outline

1. Drawing is not to scale.

Table 13. PLCC32 - 32 pin Rectangular Plastic ⊾saded Chip Carrier, package mechanical data

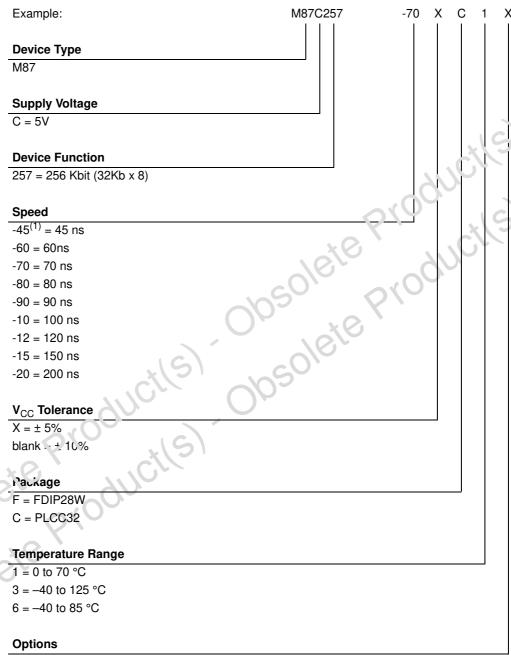
		paonago moo	millimetrars	03		inches	
	Symbol	Тур	Min	Max	Тур	Min	Max
	Α	. \	\$ 3.18	3.56		0.125	0.140
	A1	(C)	1.53	2.41		0.060	0.095
	A2	900	0.38	_		0.015	-
	В	0	0.33	0.53		0.013	0.021
	B1	(1)	0.66	0.81		0.026	0.032
\ (	CP	71/0,		0.10			0.004
0/6	D	00,	12.32	12.57		0.485	0.495
21050	D1		11.35	11.51		0.447	0.453
$O_{\mathcal{P}}$	D2		4.78	5.66		0.188	0.223
16	D3	7.62	-	_	0.300	_	-
601	Е		14.86	15.11		0.585	0.595
003	E1		13.89	14.05		0.547	0.553
O'	E2		6.05	6.93		0.238	0.273
	E3	10.16	-	_	0.400	_	-
	е	1.27	-	_	0.050	_	-
	F		0.00	0.13		0.000	0.005
	R	0.89	_	_	0.035	_	-
	N		32			32	

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# 6 Part numbering

Table 14. Ordering information scheme



TR = Tape & Reel Packing

1. High Speed, see AC Characteristics section for further information.

For a list of available options (Speed, Package, etc...) or for further information on any aspect of this device, please contact the STMicroelectronics Sales Office nearest to you.

M87C257 Revision history

# 7 Revision history

Table 15. Document revision history

	Date	Revision	Changes
	01-Jun-1996	1	Initial release.
	23-May-2006	2	Document converted to new template (sections added, information moved).  Packages are ECOPACK® compliant. Package specifications updated (see Section 5: Package mechanical).  X option removed from Table 15: Document revision history.
Obsole Obsole	te Pro	ducil	obsolete Product(s) obsolete Product(s) obsolete Product(s)

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